

## SCT3080KRC15-VB Datasheet

### N-Channel 1200V (D-S) SiC Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	1200	
$R_{DS(on)}$ at 25 °C ( $\Omega$ )	$V_{GS} = 18$ V	0.080
$Q_g$ (nC)	108	

#### FEATURES

- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)



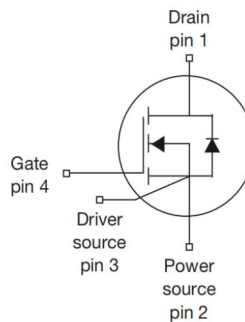
#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- DC/DC converter

TO-247-4L



- Pin1 D - Drain
- Pin2 S - Source(Power)
- Pin3 S - Source(Driver)
- Pin4 G - Gate



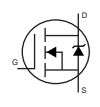
N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	$V_{DS}$	1200	V	
Gate-Source Voltage	$V_{GS}$	-10 / +22		
Continuous Drain Current ( $T_J = 150$ °C)	$V_{GS}$ at 18 V	$T_C = 25$ °C	30	A
		$T_C = 100$ °C	21	
Pulsed Drain Current <sup>a</sup>		90		
Linear Derating Factor		2.1	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	1200	mJ	
Maximum Power Dissipation	$P_D$	320	W	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +175	°C	
Drain-Source Voltage Slope	$dV/dt$	$T_J = 125$ °C	50	V/ns
Reverse Diode $dV/dt$ <sup>d</sup>		15		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s	260	°C	

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 100$  V, starting  $T_J = 25$  °C,  $L = 30$ mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 9$ A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/ $\mu$ s, starting  $T_J = 25$  °C.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	40	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.47	

SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$	1200	-	-	V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25\text{ }^\circ\text{C}, I_D = 1\text{ mA}$	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 10\text{ mA}$	2.5	-	4.5	V
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = +22\text{ V}$	-	-	100	nA
		$V_{GS} = -10\text{ V}$	-	-	100	μA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$	-	10	-	μA
		$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	100	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 18\text{ V}, I_D = 30\text{ A}$	-	0.080	-	Ω
Forward Transconductance	$g_{fs}$	$V_{DS} = 0\text{ V}, I_D = 30\text{ A}$	-	16	-	S
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 800\text{ V}, f = 1\text{ MHz}$	-	2800	-	pF
Output Capacitance	$C_{oss}$		-	123	-	
Reverse Transfer Capacitance	$C_{rss}$		-	10	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	$C_{o(er)}$	$V_{DS} = 0\text{ V to } 800\text{ V}, V_{GS} = 0\text{ V}$	-	156	-	
Effective Output Capacitance, Time Related <sup>b</sup>	$C_{o(tr)}$		-	268	-	
Total Gate Charge	$Q_g$	$V_{GS} = -5/18\text{ V}, I_D = 20\text{ A}, V_{DS} = 800\text{ V}$	-	108	-	nC
Gate-Source Charge	$Q_{gs}$		-	29	-	
Gate-Drain Charge	$Q_{gd}$		-	33	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 800\text{ V}, I_D = 20\text{ A}, V_{GS} = -5/18\text{ V}, R_g = 2\text{ }^\Omega$	-	18	25	ns
Rise Time	$t_r$		-	24	55	
Turn-Off Delay Time	$t_{d(off)}$		-	80	-	
Fall Time	$t_f$		-	12	-	
Gate Input Resistance	$R_g$	$f = 1\text{ MHz}, \text{ open drain}$	-	3.2	-	Ω
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	30	A
Pulsed Diode Forward Current	$I_{SM}$		-	-	90	
Diode Forward Voltage	$V_{SD}$	$T_J = 25\text{ }^\circ\text{C}, I_S = 30\text{ A}, V_{GS} = 0$	-	-	4.1	V
Reverse Recovery Time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}, I_F = I_S = 30\text{ A}, di/dt = 1000\text{ A}/\mu\text{s}, V_R = 800\text{ V}$	-	70	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	220	-	μC
Reverse Recovery Current	$I_{RRM}$		-	60	-	A

**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

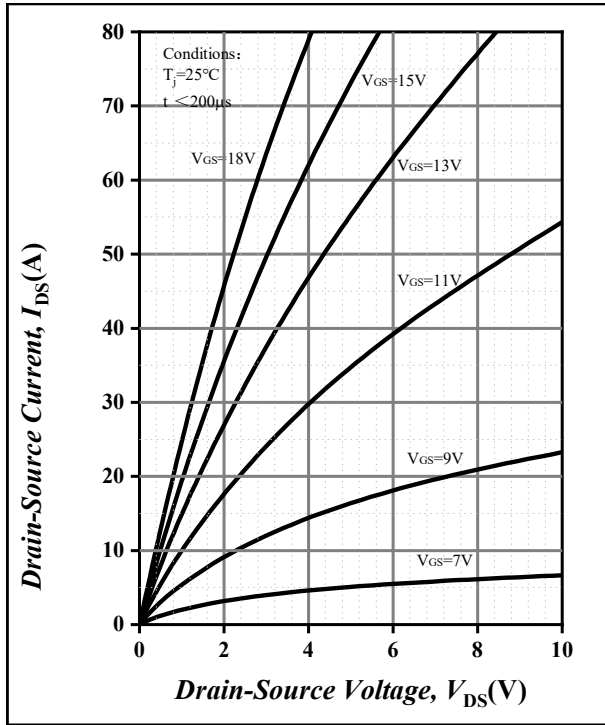


Fig.1 Output characteristics  $T_j=25^\circ\text{C}$

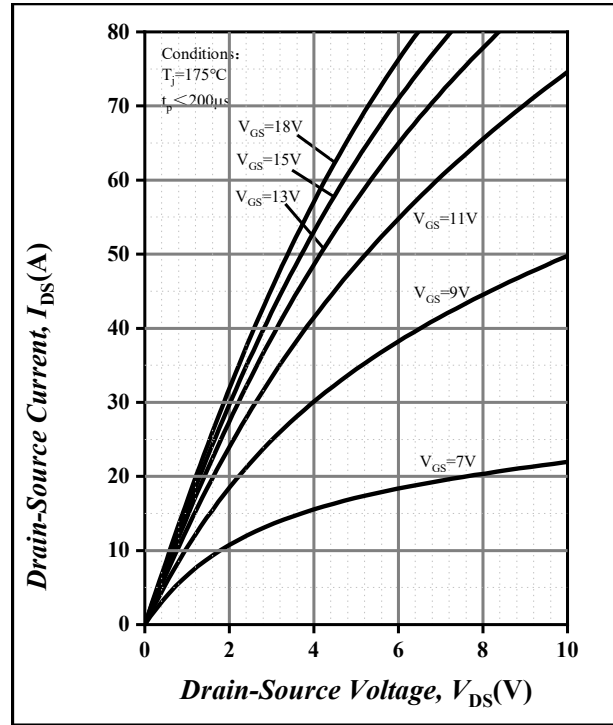


Fig.2 Output characteristics  $T_j=175^\circ\text{C}$

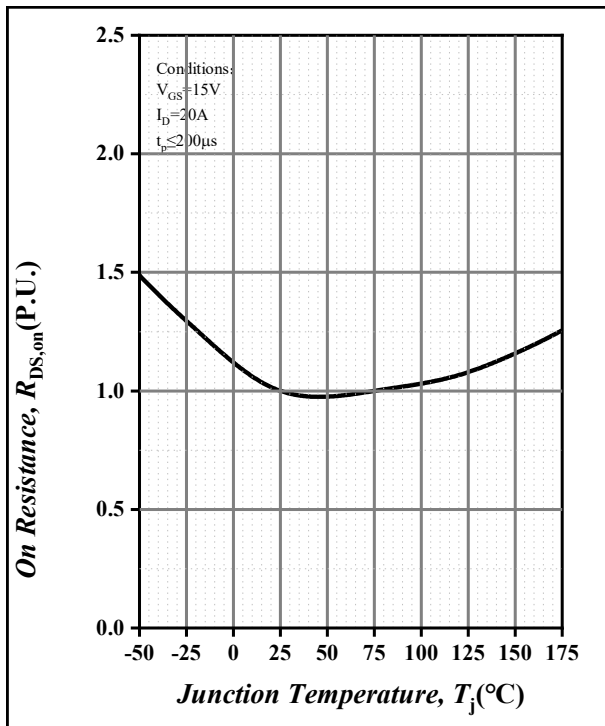


Fig.3 Normalized On-Resistance vs. Temperature

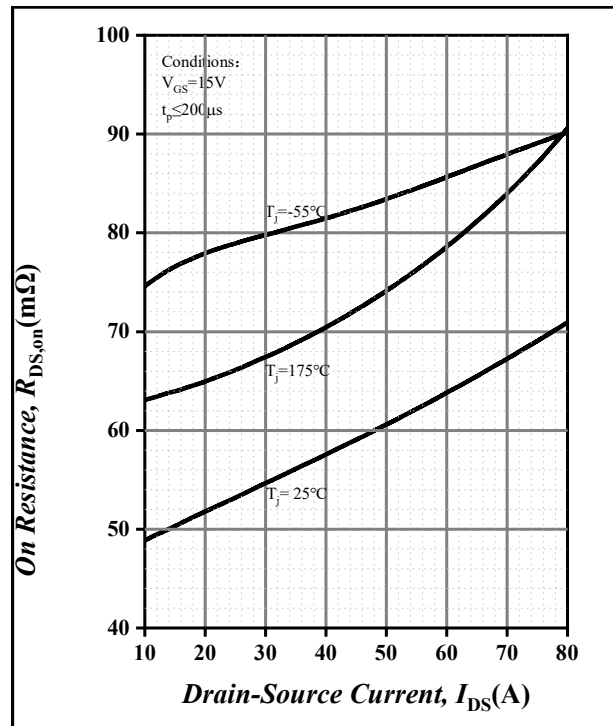


Fig.4 On-Resistance vs. Drain Current For Various Temperatures

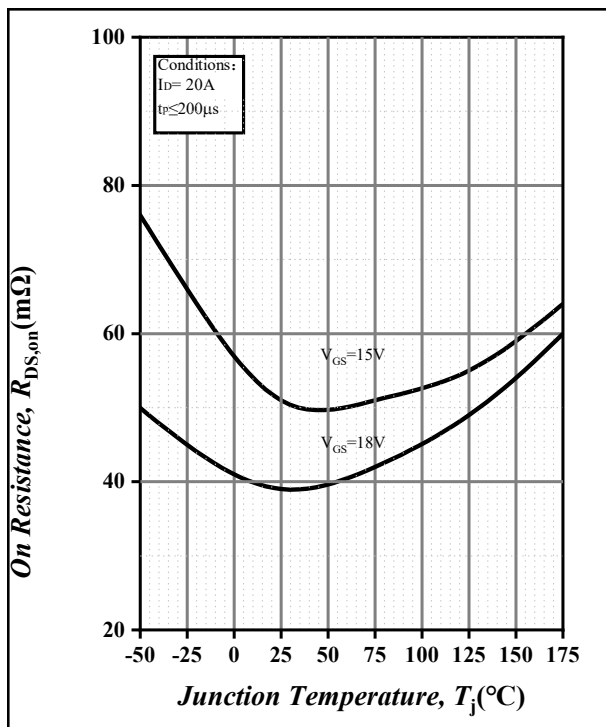


Fig.5 On-Resistance vs. Temperature For Various Gate Voltage

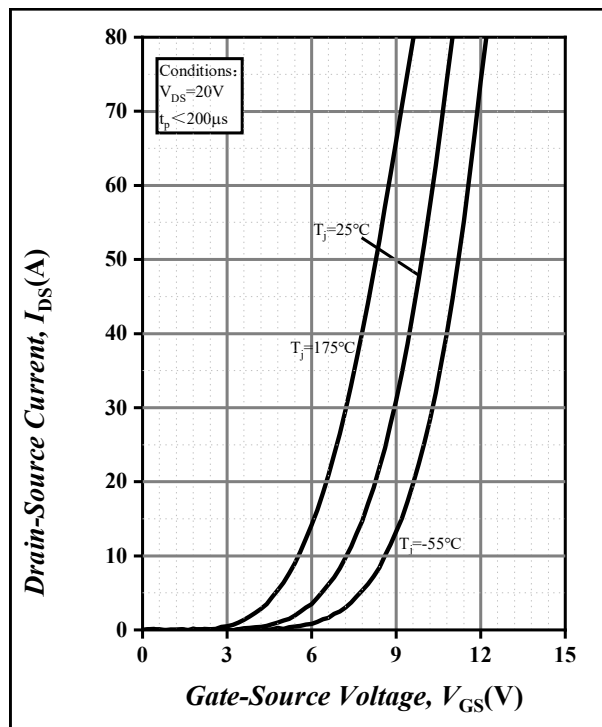


Fig.6 Transfer Characteristic For Various Junction Temperatures

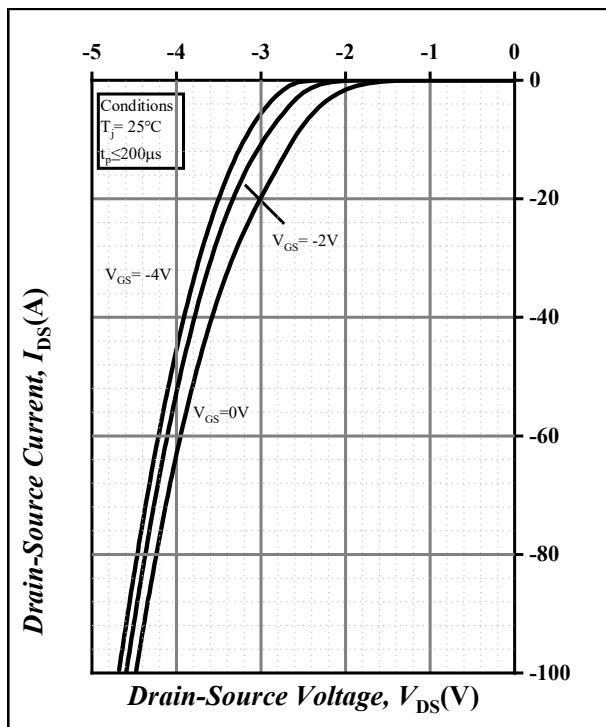


Fig.7 Body Diode Characteristic at 25 $^{\circ}$ C

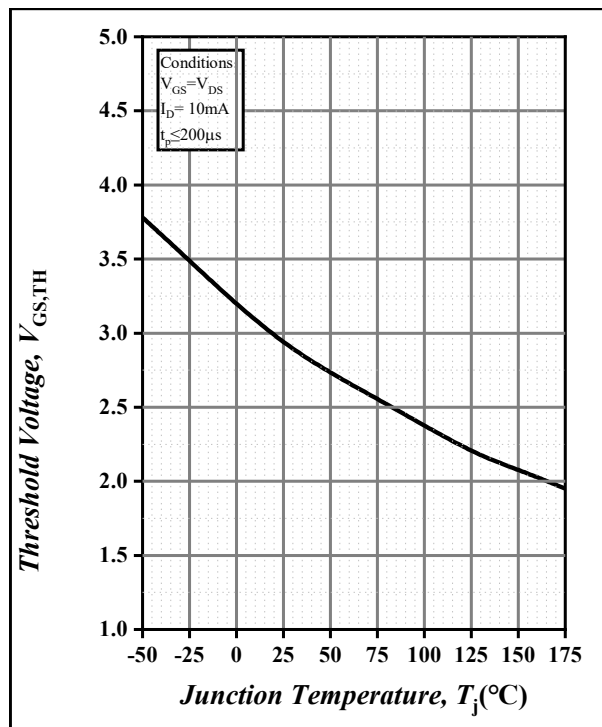


Fig.8 Threshold Voltage vs. Temperature



Fig.9 Gate Charge Characteristics

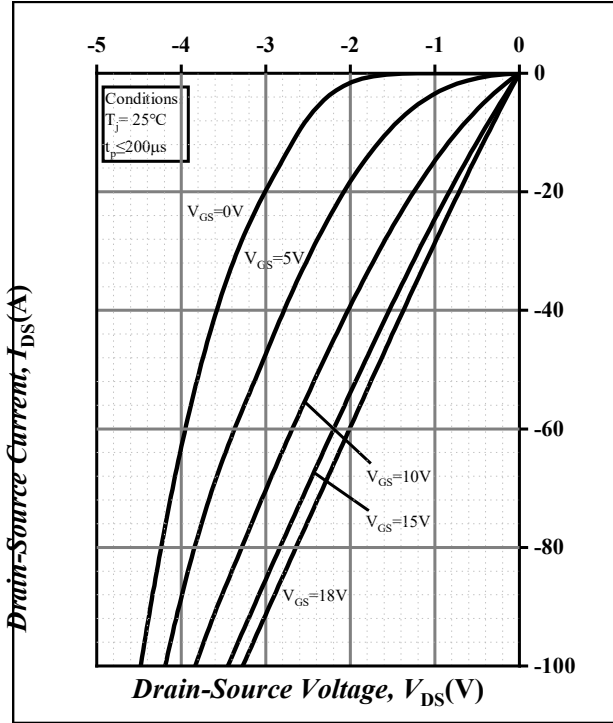


Fig.10 3<sup>rd</sup> Quadrant Characteristic at 25°C

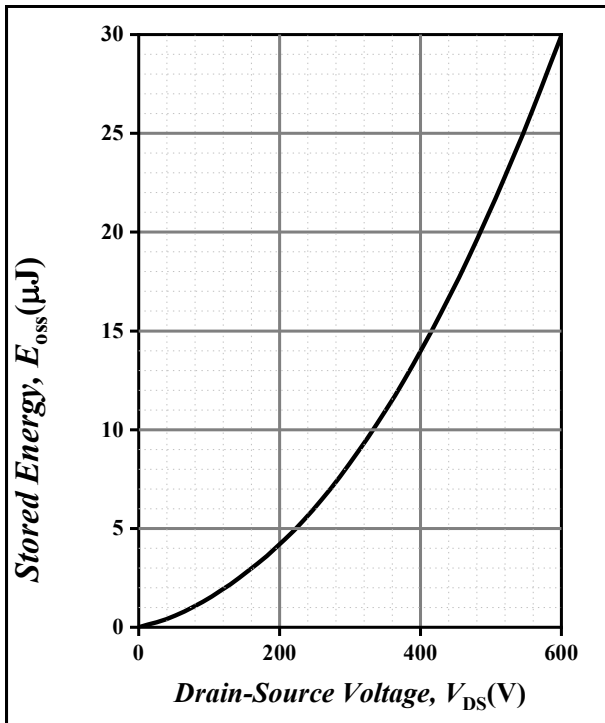


Figure 11. Output Capacitor Stored Energy



Fig.12 Capacitances vs. Drain-Source Voltage(0-200V)

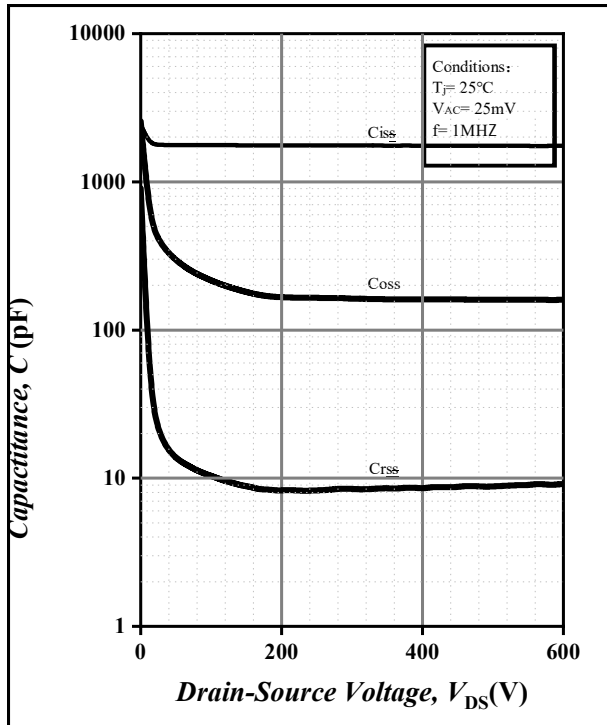


Fig.13 Capacitances vs. Drain-Source Voltage(0-600V)

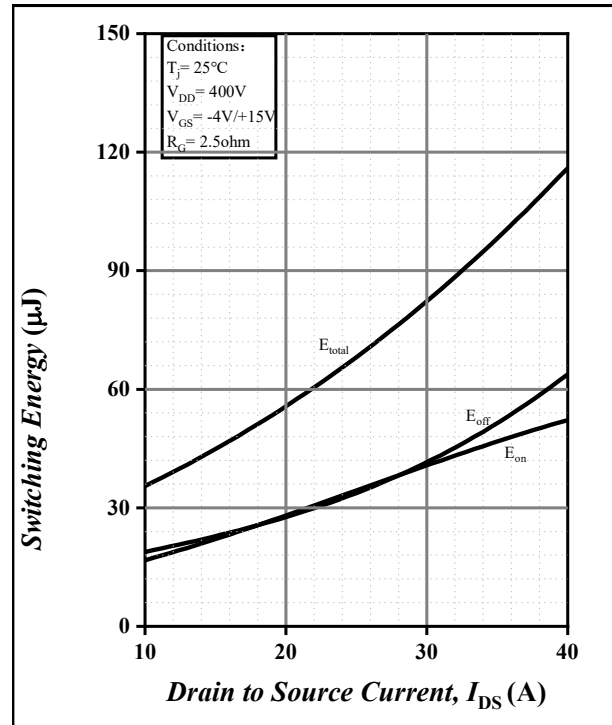


Figure 14. Clamped Inductive Switching Energy vs. Drain Current( $V_{DD}=400\text{V}$ )

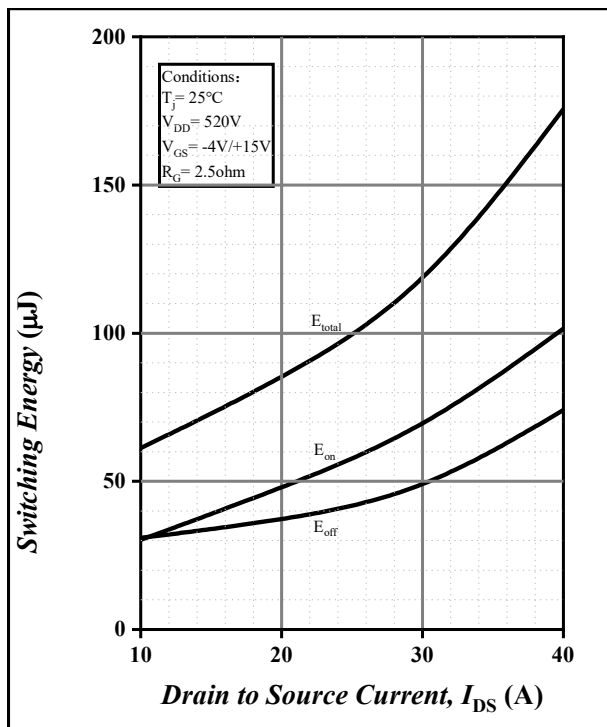


Figure 15. Clamped Inductive Switching Energy vs. Drain Current( $V_{DD}=520\text{V}$ )

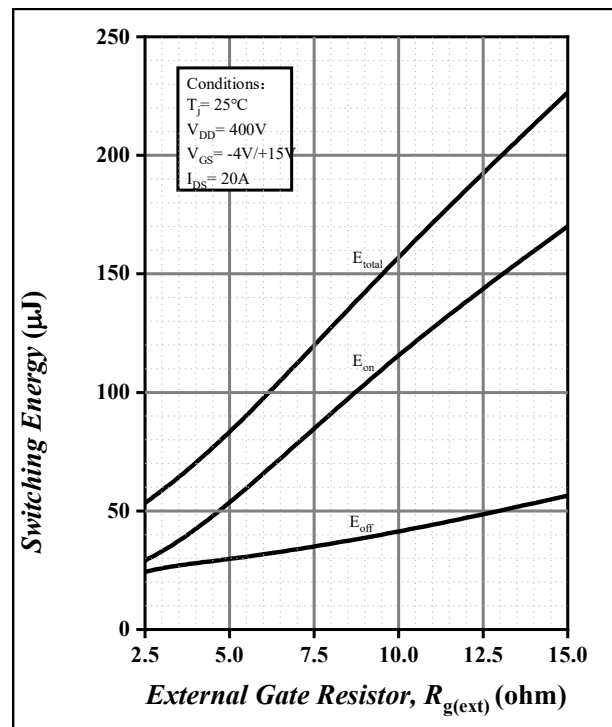


Figure 16. Clamped Inductive Switching Energy vs.  $R_{g(\text{ext})}$

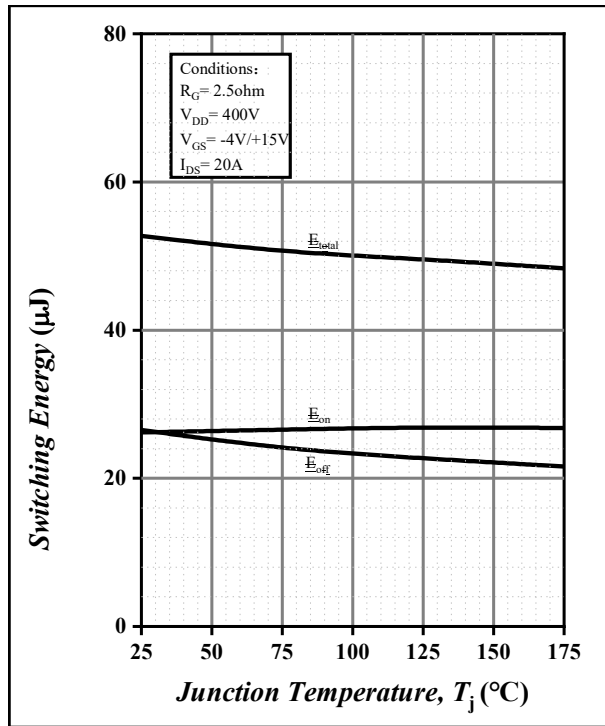
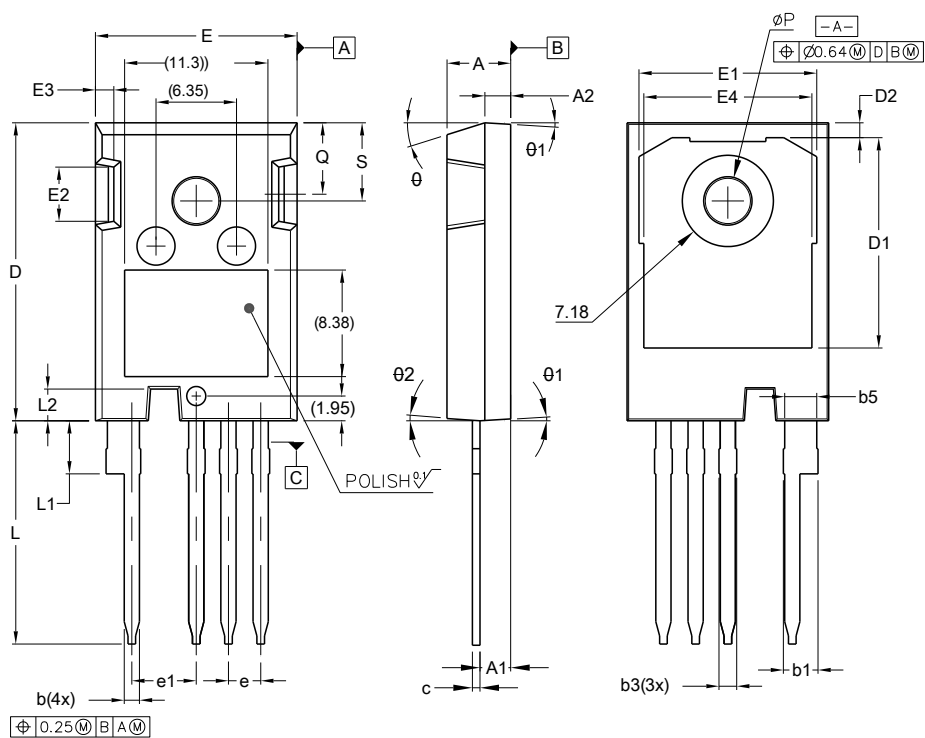


Figure 17. Clamped Inductive Switching Energy vs. Temperature



Figure 18. Switching Times vs.  $R_{g(ext)}$

### TO247-4L Package Outline Dimensions



TO247-4 Standard		
Dim	Min	Max
<b>A</b>	4.83	5.21
<b>A1</b>	2.29	2.54
<b>A2</b>	1.91	2.16
<b>b</b>	1.07	1.33
<b>b1</b>	2.39	2.94
<b>b3</b>	1.07	1.60
<b>b5</b>	2.39	2.69
<b>c</b>	0.55	0.68
<b>D</b>	23.30	23.60
<b>D1</b>	16.25	17.65
<b>D2</b>	0.95	1.25
<b>E</b>	15.75	16.30
<b>E1</b>	13.10	14.15
<b>E2</b>	3.68	5.10
<b>E3</b>	1.00	1.90
<b>E4</b>	12.38	13.43
<b>e</b>	2.54 BSC	
<b>e1</b>	5.08 BSC	
<b>L</b>	17.31	17.82
<b>L1</b>	3.97	4.37
<b>L2</b>	2.35	2.65
<b>ØP</b>	3.51	3.65
<b>Q</b>	5.49	6.00
<b>S</b>	6.04	6.30
<b>θ</b>	17.5° - 20° REF	
<b>θ1</b>	3.5° - 5° REF	
<b>θ2</b>	4° - 5° REF	
<b>All Dimensions in mm</b>		

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